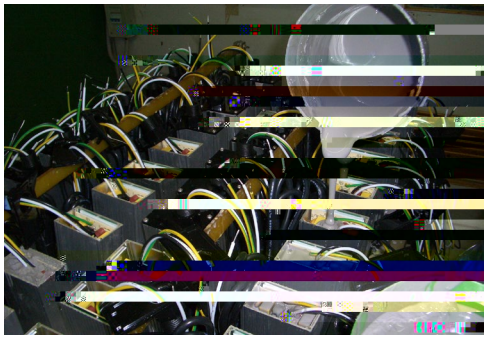
TDS A4 2025.12



/

/

thermally conductive potting compound is a two-component additional type silicone base with high thermal conductivity, good flowability, low density, superior electrical insulation and flame retardancy. It’s suitable for high-power devices such as high-power supplies and modules, current/power conversion units, high power on-board chargers and charging piles. The product can meet the requirements for high thermal conductivity in the electrical/electronic packaging field and maintaining silicone polymer characteristics.

- Low Viscosity
- Low Density
- Easy Handling
- High Reliability

| | | | |
|---|---|---|---|
| | | | |

- Motor Potting
- Power Module
- Charging Pile
- ADAS

All technical information stated in this technical data have been confirmed that all the technical parameters are reliable after harsh testing and evaluation of the products. Before you use our products, please carefully evaluate and decide whether the product meets your requirement and you need to take all the risks and responsibilities to use.